GBU4A THRU GBU4M

SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIERS

GBU

FEATURES:

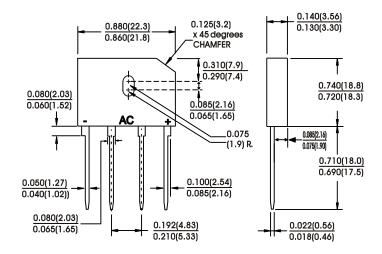
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High case dielectric strength of 1500 V_{RMS}
- Ideal for printed circuit boards
- Glass passivated chip junction
- High surge overload rating
- High temperature soldering guaranteed:
 260 ℃/10 seconds 0.375" (9.5mm) lead Length

MECHANICAL DATA

Case: Molded plastic body over passivated junctions Terminals: Plated leads solderable per MIL-STD-750,

Method 2026

Mounting Position: Any (NOTE 2)



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25° C ambient temp. unless otherwise specified.

Single phase, half sine wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20 %.

Characteristic	Symbol	GBU 4A	GBU 4B	GBU 4D	GBU 4G	GBU 4J	GBU 4K	GBU 4M	Units
Maximum recurrent peak reverse voltage	VRRM	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	Volts
Maximum DC voltage	VDC	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current atTc=100°C (NOTE1, 2)	lo	4.0							Amps
Peak forward surge current, 8.3 ms single half sine-wave auperimposed on rated load (JEDEC Methed)	I _{FSM}	150							Amps
Rating for fusing(t<8.3ms)	I ² T	93.0							A ² Sec
Maximum instantaneous forward voltage drop per leg at 4.0A	V _F	1.1							Volts
Maximum DC reverse currentat rated $Ta=25^{\circ}C$ DC blocking voltage (Per leg) $Ta=125^{\circ}C$	I _R	5.0 500							μ Α
Typical junction (Per leg) (NOTE3)	CJ	100.0 45.0						PF	
Typical thermal resistance (Per leg) (NOTE1, 2)	Rth JA Rth JL	22 4.2							° C/W
Operating Junction and storage temperature range	TJ, Tstg	-55 to+150							${\mathfrak C}$

NOTES:

compound for maximum heat transfer with #6 screws

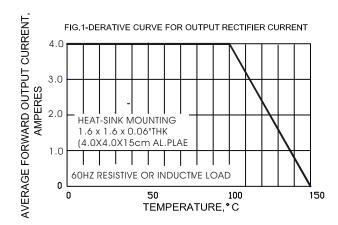
(3)Measured at 1.0 MHZ and applied reverse of 4.0 Volts

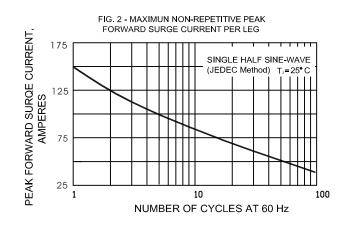
⁽¹⁾Unit case mounted on 1.6 x 1.6 x 0.06"thick(4.0 x 4.0 x 0.15cm) Al.plate heatsink

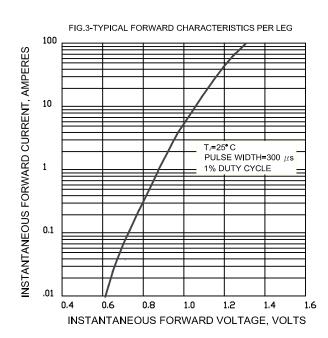
⁽²⁾Recommended mounted position is bolt to down on heatsink with silicone thermal

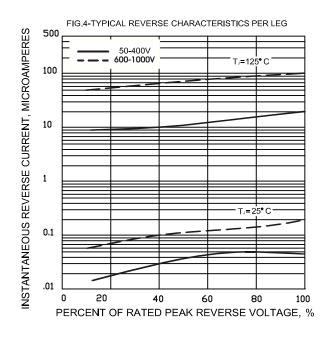
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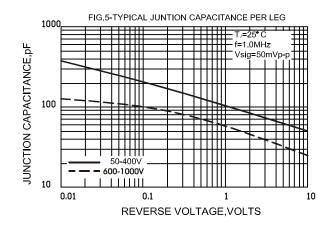
RATINGS AND CHARCTERISTIC CURVES

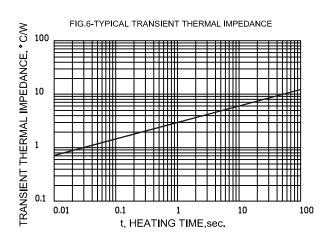












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